

Title (en)  
CONTACTING ELEMENTS

Title (de)  
KONTAKTIERUNGSELEMENTE

Title (fr)  
ÉLÉMENTS DE MISE EN CONTACT

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Application  
**EP 12725386 A 20120531**

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Abstract (en)  
[origin: WO2012171808A2] The invention relates to a contacting element (10) which in particular is formed as a contact spring. The contacting element (10) comprises spring-loaded contact spring limbs (20) which electrically contact a contact surface (32) of a contact pin (30). The contacting element (10) contacts a printed circuit board (48) which is provided with at least one printed circuit board cut-out (34). A plurality of electrically conducting contact points (26a, 26b, 28; 14, 48; 46, 48; 56, 58) are formed between the printed circuit board (48) and the contacting element (10).

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